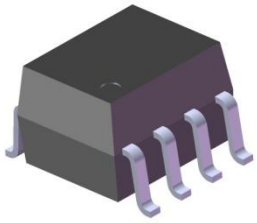
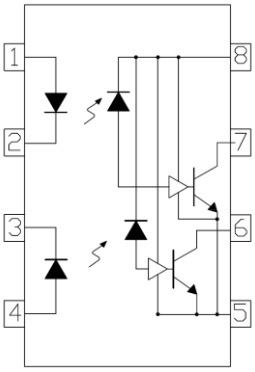
DATASHEET

8 PIN SOP DUAL CHANNEL HIGH SPEED 10MBit/s LOGIC GATE PHOTOCOUPLER EL063X Series



Schematic



Features

- Compliance Halogen Free .
  (Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)
- High speed 10Mbit/s
- 10kV/μs min. common mode transient immunity (EL0631)
- Guaranteed performance from -40 to 85°C
- Wide operating temperature range of -40°C to 100°C
- Logic gate output
- High isolation voltage between input and output (Viso=3750 V rms)
- Compliance with EU REACH
- Pb free and RoHS compliant
- UL and cUL approved(No. E214129)
- VDE approved (No.40028116)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

Pin Configuration

1. Anode
2. Cathode
3. Cathode
4. Anode
5. Gnd
6. Vout 2
7. Vout 1
8. V_{CC}

Description

The EL0630 and EL0631 are dual channel devices each consists of an infrared emitting diode optically coupled to a high speed integrated photo detector logic gate with a strobable output.
The devices are packaged in an 8-pin small outline package which conforms to the standard SO8 footprint.

Applications

- Ground loop elimination
- LSTTL to TTL, LSTTL or 5 volt CMOS
- Line receiver, data transmission
- Data multiplexing
- Switching power supplies
- Pulse transformer replacement
- Computer peripheral interface

Truth Table (Positive Logic)

Input	Output
H	L
L	H

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	DC/ Average Forward current	I_F	20	mA
	Reverse voltage	V_R	5	V
	Power dissipation	P_D	45	mW
Output	Power dissipation	P_C	60	mW
	Output current	I_O	50	mA
	Output voltage	V_O	7.0	V
	Supply voltage (max 1 minute)	V_{CC}	7.0	V
Output Power Dissipation		P_O	80	mW
Isolation voltage *1		V_{ISO}	3750	V rms
Operating temperature		T_{OPR}	-40 ~ +100	°C
Storage temperature		T_{STG}	-55 ~ +125	°C
Soldering temperature *2		T_{SOL}	260	°C

Notes:
*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2, 3, 4 are shorted together, and pins 5, 6, 7, 8 are shorted together.

*2 For 10 seconds

Electrical Characteristics (Ta=-40 to 85°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward voltage	V_F	-	1.4	1.8	V	I_F =10mA
Reverse voltage	V_R	5.0	-	-	V	I_R =10μA
Temperature coefficient of forward voltage	$\Delta V_F/\Delta T_A$	-	-1.8	-	mV/°C	I_F =10mA
Input capacitance	C_{IN}	-	60	-	pF	V_F =0, f=1MHz

Output

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
High level supply current	I_{CCH}	-	13	18	mA	I_F =0mA, V_{CC} =5.5V
Low level supply current	I_{CCL}	-	15	21	mA	I_F =10mA, V_{CC} =5.5V

Transfer Characteristics (Ta=-40 to 85°C unless specified otherwise)

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
HIGH Level Output Current	I_{OH}	-	-	100	μA	V_{CC}=5.5V, V_O =5.5V, I_F =250μA,
LOW Level Output Current	V_{OL}	-	-	0.6	V	V_{CC} =5.5V, I_F =5mA, I_{CL} =13mA
Input Threshold Current	I_{FT}	-	-	5	mA	V_{CC} =5.5V, V_O =0.6V, I_{OL} =13mA

Switching Characteristics (T_a=-40 to 85°C, V_{CC}=5V, I_F=7.5mA unless specified otherwise)

Parameter		Symbol	Min	Typ.	Max.	Unit	Condition
Propagation delay time to output High level*4 (Fig.11)		t_{PHL}	-	-	100	ns	C_L =15pF, R_L=350Ω, T_A =25°C
Propagation delay time to output Low level*5 (Fig.11)		t_{PLH}	-	-	100	ns	C_L =15pF, R_L=350Ω, T_A =25°C
Pulse width distortion		$\lvert t_{PHL} - t_{PLH} \rvert$	-	-	35	ns	C_L =15pF, R_L =350Ω
Output rise time*6 (Fig.11)		t_r	-	40	-	ns	C_L =15pF, R_L =350Ω
Output fall time*7 (Fig.11)		t_f	-	10	-	ns	C_L =15pF, R_L =350Ω
Common Mode Transient Immunity at Logic High*8	EL0630	$\lvert CM_H \rvert$	5000	-	-	V/µs	I_F =0mA ,$V_{OH(MIN)}$ =2.0V, R_L =350Ω, T_A =25°C $\lvert V_{CM} \rvert$ =1KV(Fig.12)
	EL0631		10000				I_F = 0mA ,$V_{OH(MIN)}$=2.0V, R_L=350Ω, T_A=25°C $\lvert V_{CM} \rvert$=1KV(Fig.12)
Common Mode Transient Immunity at Logic Low*9	EL0630	$\lvert CM_L \rvert$	5000	-	-	V/µs	I_F =7.5mA,$V_{OL(MAX)}$ =0.8V, R_L =350Ω, T_A =25°C $\lvert V_{CM} \rvert$ =1KV(Fig.12)
	EL0631		10000				I_F =7.5mA,$V_{OL(MAX)}$ =0.8V, R_L =350Ω, T_A =25°C $\lvert V_{CM} \rvert$ =1KV(Fig.12)

Typical Electro-Optical Characteristics Curves

Fig.1 Input Diode Forward Voltage vs. Forward Current

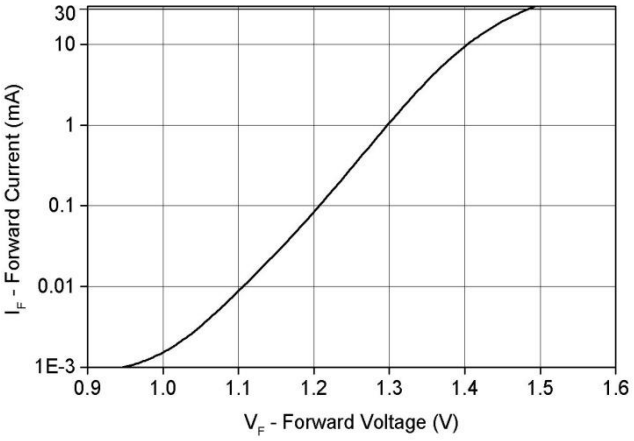


Fig.2 Low Level Output Voltage vs. Ambient Temperature

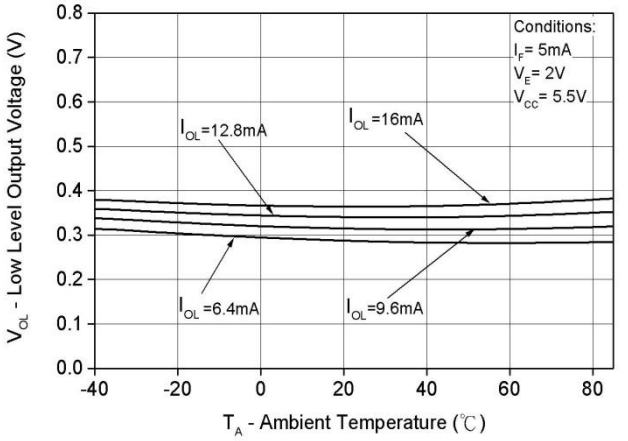


Fig.3 Low Level Output Current vs. Ambient Temperature

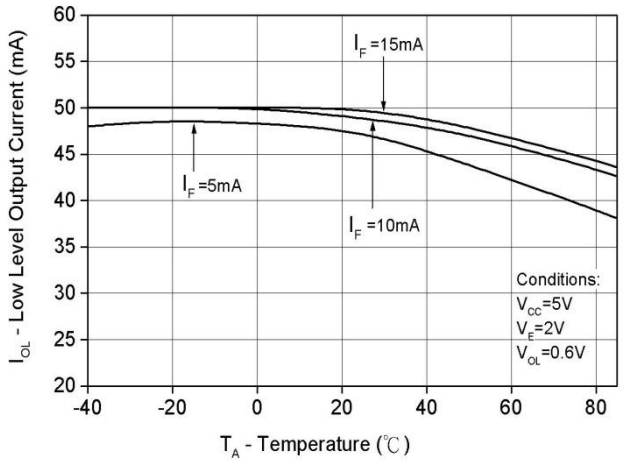


Fig.4 Input Threshold Current vs. Ambient Temperature

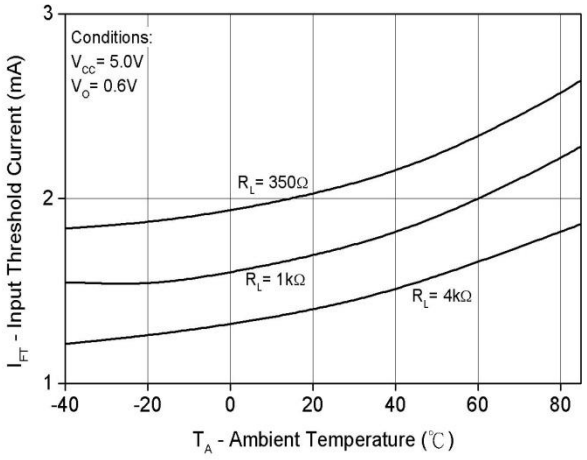


Fig.5 Output Voltage vs. Input Forward Current

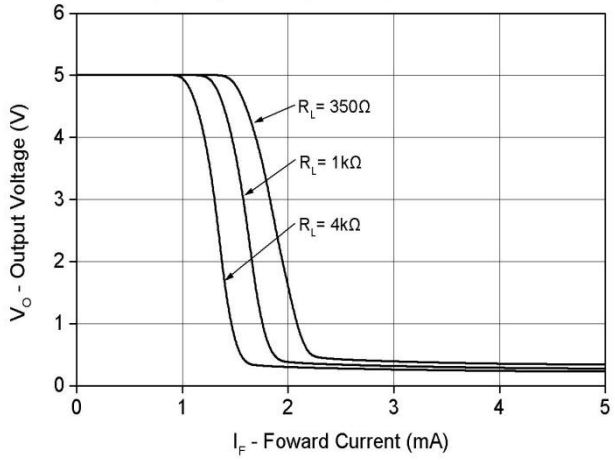


Fig.6 High Level Output Current vs. Temperature

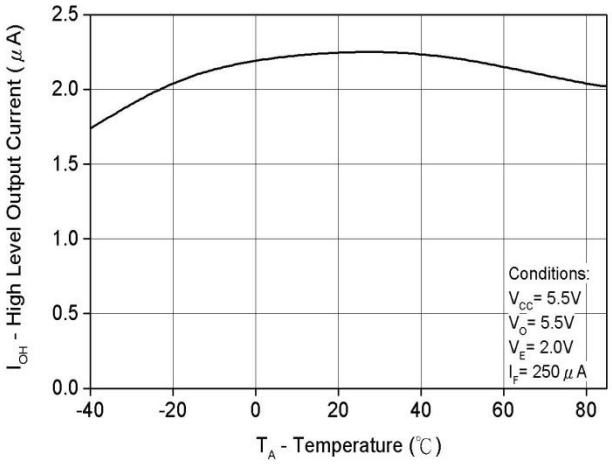


Fig.7 Switching Time vs. Forward Current

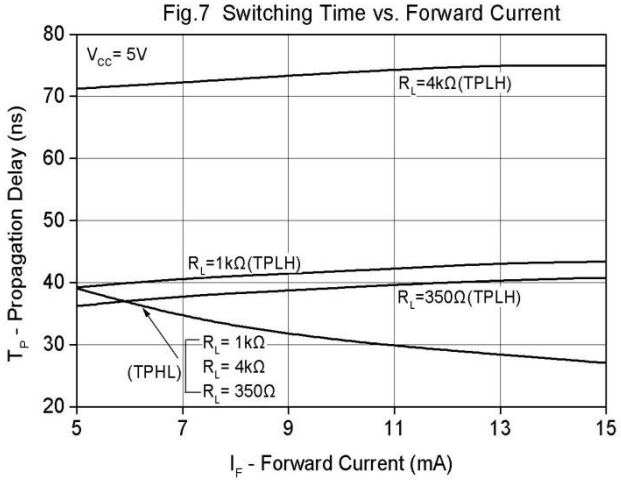


Fig.8 Switching Time vs. Temperature

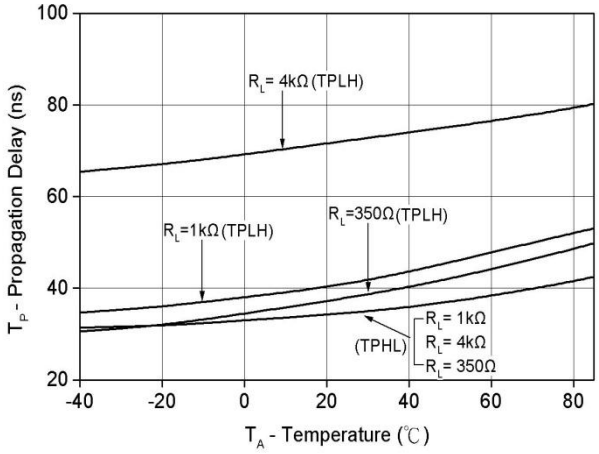


Fig.9 Pulse Width Distortion vs. Temperature

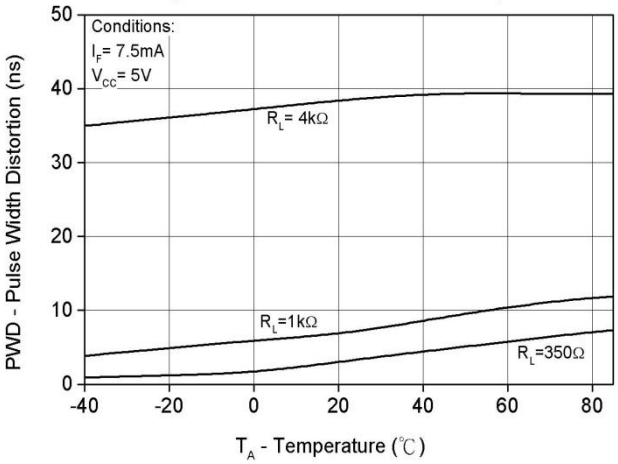


Fig.10 Rise and Fall Time vs. Temperature

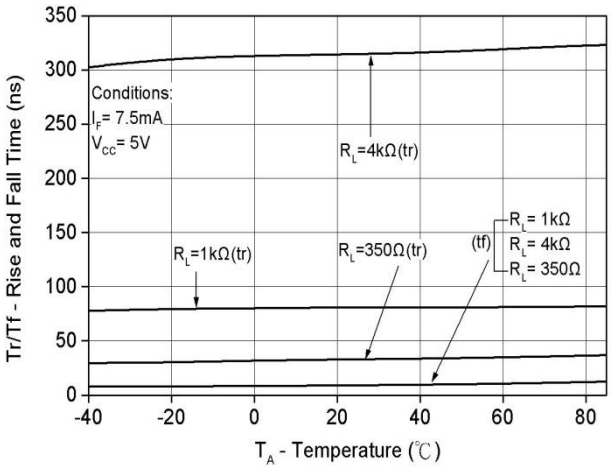


Fig. 11 Test circuit and waveforms for t_{PHL}, t_{PLH}, t_r, and t_f

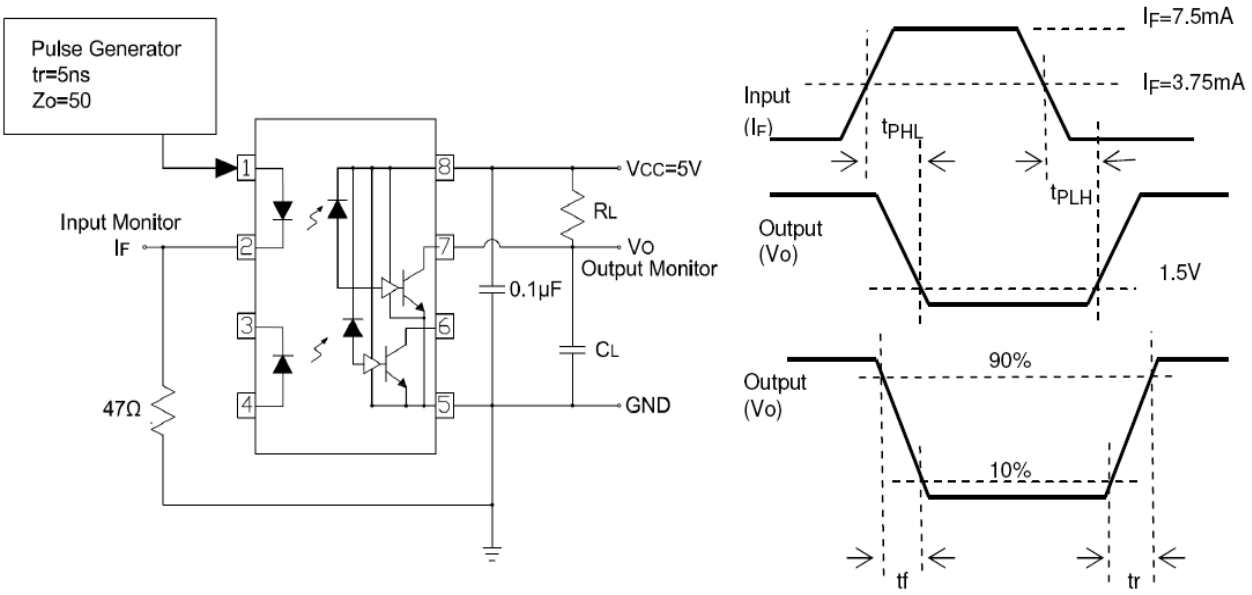
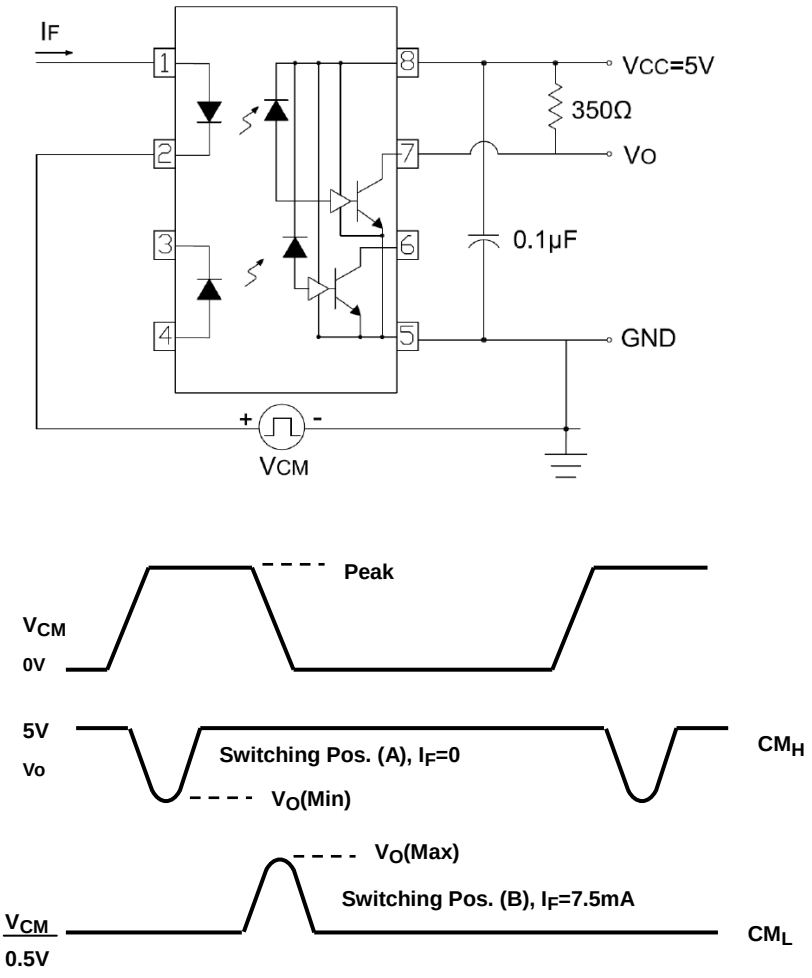


Fig. 12 Test circuit Common mode Transient Immunity



Notes

*3 The V_{CC} supply must be bypassed by a 0.1μF capacitor or larger. This can be either a ceramic or solid tantalum capacitor with good high frequency characteristic and should be connected as close as possible to the package V_{CC} and GND pins

*4. t_{PLH} – Propagation delay is measured from the 3.75mA level on the HIGH to LOW transition of the input current pulse to the 1.5 V level on the LOW to HIGH transition of the output voltage pulse.

*5. t_{PHL} – Propagation delay is measured from the 3.75mA level on the LOW to HIGH transition of the input current pulse to the 1.5 V level on the HIGH to LOW transition of the output voltage pulse.

*6. t_r – Rise time is measured from the 90% to the 10% levels on the LOW to HIGH transition of the output pulse.

*7. t_f – Fall time is measured from the 10% to the 90% levels on the HIGH to LOW transition of the output pulse.

*8 CM_H – The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the HIGH state (i.e., V_{OUT} > 2.0V).

*9 CM_L – The maximum tolerable rate of rise of the common mode voltage to ensure the output will remain in the LOW output state (i.e., V_{OUT} < 0.8V).

Order Information

Part Number

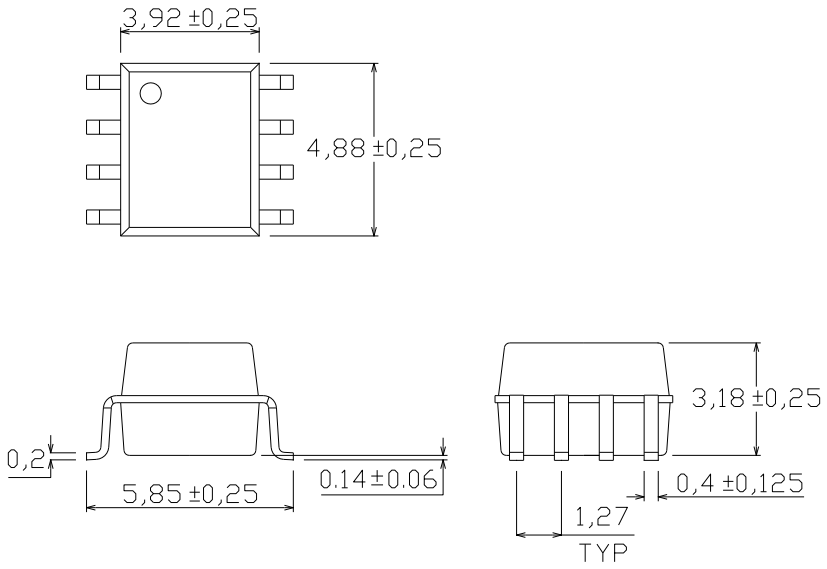
EL063X(Z)-V

Note

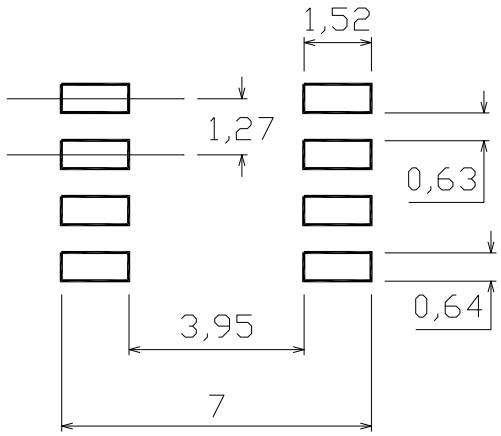
X = Part no. (X = 0 or 1)
Z = Tape and reel option (TA, TB or none).
V = VDE (optional)

Option	Description	Packing quantity
None	Standard	100 units per tube
-V	Standard + VDE	100 units per tube
(TA)	TA tape & reel option	2000 units per reel
(TB)	TB tape & reel option	2000 units per reel
(TA)-V	TA tape & reel option + VDE	2000 units per reel
(TB)-V	TB tape & reel option + VDE	2000 units per reel

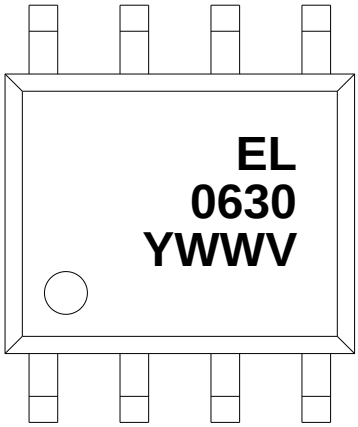
Package Dimension
(Dimensions in mm)



Recommended pad layout for surface mount leadform



Device Marking

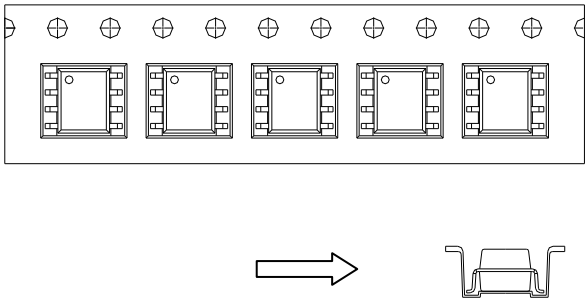


Notes

0630	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

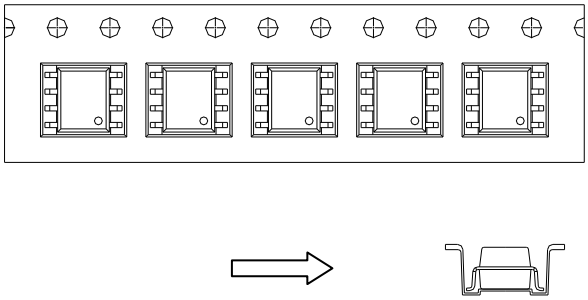
Tape & Reel Packing Specifications

Option TA



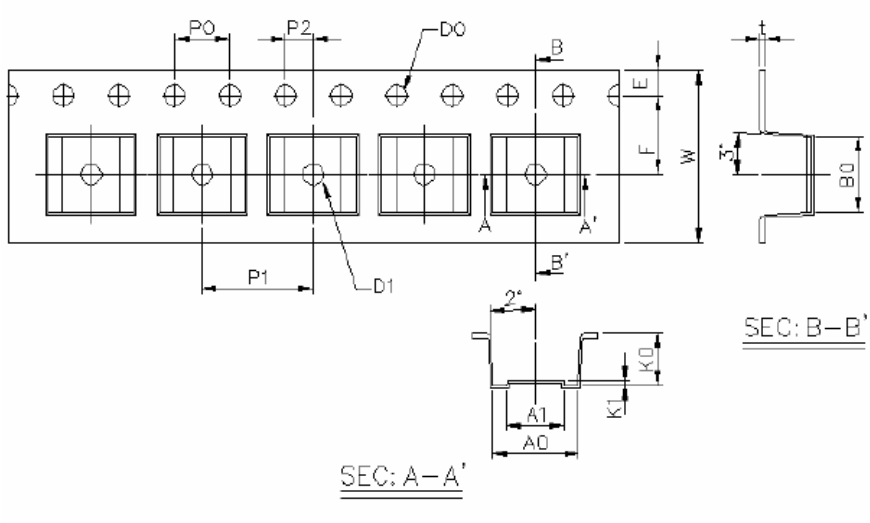
Direction of feed from reel

Option TB



Direction of feed from reel

Tape dimensions

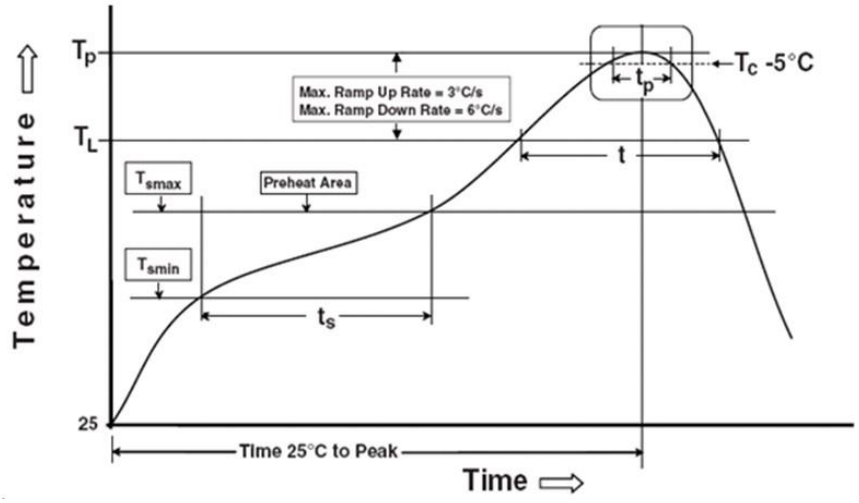


Dimension No.	**A0**	**A1**	**B0**	**D0**	**D1**	**E**	**F**
Dimension(mm)	6.2±0.1	4.1±0.1	5.28±0.1	1.5±0.1	1.5±0.3	1.75±0.1	5.5±0.1
Dimension No.	**Po**	**P1**	**P2**	**t**	**W**	**K0**	**K1**
Dimension(mm)	4.0±0.1	8.0±0.1	2.0±0.1	0.4±0.1	12.0+0.3/ -0.1	3.7±0.1	0.3±0.1

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

Preheat	
Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max
Other	
Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_P)	260°C
Time within 5 °C of Actual Peak Temperature: T_P - 5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

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